

- **Advanced, Integrated Speech Synthesizer for High-Quality Sound.**
- **Operates up to 12.32 MHz (Performs up to 12 MIPS)**
- **Single Chip Solution for up to 24 Minutes of Speech (Using 1.57 Mb of Onboard Program + Data ROM)**
- **Supports High-Quality Synthesis Algorithms Such as MELP, CELP, LPC, ADPCM, and Polyphonic Music**
- **Simultaneous Speech Plus Music Capabilities**
- **Very Low-Power Operation, Ideal for Hand-Held Devices.**
- **Low-Voltage Operation, Sustainable by Three Batteries**
- **Reduced Power Stand-By Modes, Less Than 10 μ A in Deep-Sleep Mode**
- **640-Word RAM**
- **32 I/O Pins Consisting of**
 - 24 General Purpose Bit Configurable I/O
 - 8 Inputs With Programmable Pullup Resistor And a Dedicated Interrupt (Key-Scan)
- **Direct Speaker Driver, 32 Ω (PDM)**
- **One-Bit Comparator With Edge-Detection Interrupt Service**
- **Resistor-Trimmed Oscillator or 32.768 kHz Crystal Reference Oscillator**
- **Serial Scan Port for In-Circuit Emulation and Diagnostics**
- **The MSP50C601 Is Sold in Die Form or 100-Pin PJM Package.**
- **An Emulator Device Is Available in a Ceramic Package for Development**

description

The MSP50C601 is a low-cost, mixed-signal processor that combines a speech synthesizer, general-purpose I/O, onboard ROM, and direct speaker drive in a single package. The computational unit utilizes a powerful new DSP which gives the MSP50C601 unprecedented speed and computational flexibility compared with previous devices of its type. The MSP50C601 supports a variety of speech and audio coding algorithms, providing a range of options for speech duration and sound quality.

The device consists of a micro-DSP core, embedded program, and data memory, and a self-contained clock generation system. General-purpose periphery is comprised of 32 bits of partially configurable I/O.

The core processor is a general-purpose 16-bit microcontroller with DSP capability. The basic core block includes computational unit (CU), data address unit, program address unit, two timers, eight level interrupt processor, and several system and control registers. The core processor gives the MSP50C601 break-point capability in emulation.

The processor is Harvard type for efficient DSP algorithm execution. It requires separate program and data memory blocks to permit simultaneous access. The ROM has a protection scheme to prevent third-party pirating. It is configured in 32K 17-bit words.

The total ROM space is divided into three areas: 1) The lower 2K words are reserved by Texas Instruments for a built-in self-test 2) The upper 30K words are for user program/data 3) An additional 1 Mb data ROM provides for up to 24 minutes of speech.

The data memory is internal static RAM. The RAM is configured in 640 17-bit words. All memories are designed to consume minimum power at a given system clock and algorithm acquisition frequency.

Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

MSP50C601
MIXED-SIGNAL PROCESSOR

SPSS029A – SEPTEMBER 2000 – REVISED FEBRUARY 2001

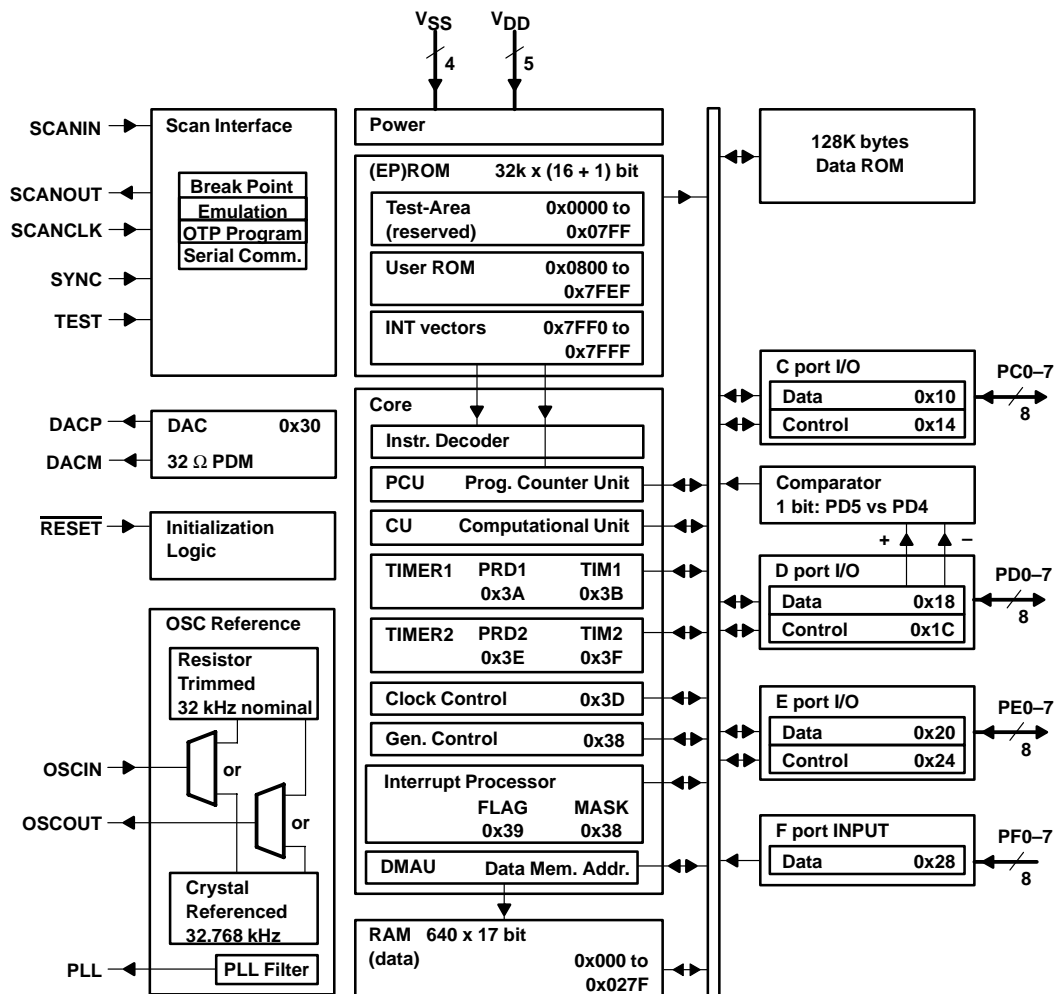
description (continued)

A flexible clock generation system enables the software to control the clock over a wide frequency range. The implementation uses a phase-locked loop (PLL) circuit that drives the processor clock at a selectable frequency between the minimum and maximum achievable. Selectable frequencies for the processor clock are spaced apart in 65.536 kHz steps. The PLL clock-reference is also selectable; either a resistor-trimmed oscillator or a crystal-referenced oscillator may be used. Internal and external clock sources are controlled separately to provide different levels of power management.

The periphery consists of three 8-bit wide general-purpose I/O ports and one 8-bit wide dedicated input port. The bidirectional I/O can be configured under software control as either high-impedance inputs or as totem-pole outputs. They are controlled via addressable I/O registers. The input-only port has a programmable pullup option (70-k Ω minimum resistance) and a dedicated service interrupt. These features make the input port especially useful as a key-scan interface.

A simple one-bit comparator is also included in the periphery. The comparator is enabled by a control register, and its pin access is shared with two pins in one of the general-purpose I/O ports. Rounding out the MSP50C601 periphery is a built-in pulse-density-modulated DAC (digital-to-analog converter) with direct speaker-drive capability. The functional block diagram gives an overview of the MSP50C601 functionality.

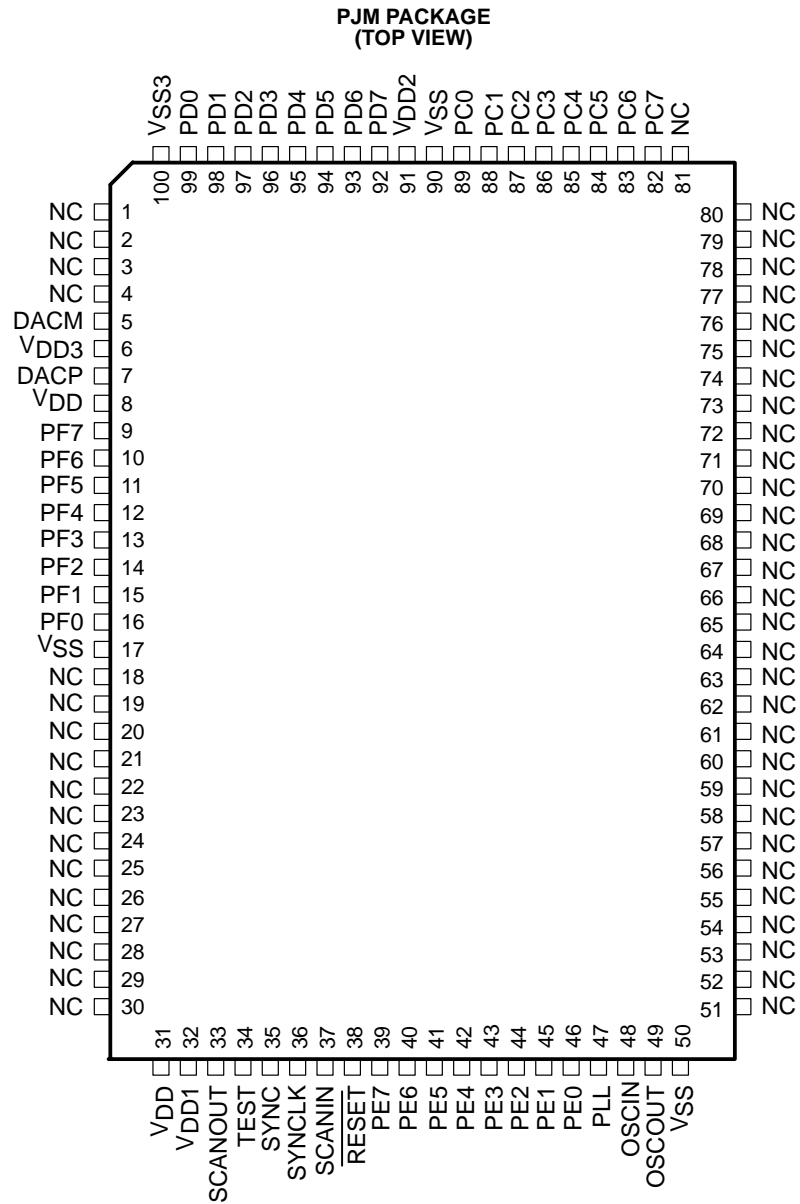
functional block diagram



MSP50C601
MIXED-SIGNAL PROCESSOR

SPSS029A – SEPTEMBER 2000 – REVISED FEBRUARY 2001

pin assignments



NC – No internal connection

MSP50C601

MIXED-SIGNAL PROCESSOR

SPSS029A – SEPTEMBER 2000 – REVISED FEBRUARY 2001

Terminal Functions

NAME	PIN NO.	PAD NO.	I/O	DESCRIPTION
Input/Output Ports				
PC0 – PC7	89 – 82	8 – 1	I/O	Port C general-purpose I/O (1 Byte)
PD0 – PD7	99 – 92	18 – 11	I/O	Port D general-purpose I/O (1 Byte)
PE0 – PE7	46 – 39	48 – 41	I/O	Port E general-purpose I/O (1 Byte)
PF0 – PF7	16 – 9	31 – 24	I	Port F key-scan input (1 Byte)
Pins PD ₄ and PD ₅ may be dedicated to the comparator function, if the comparator enable bit is set. Refer to Section 3.3, <i>Comparator</i> , for details.				
Scan Port Control Signals				
SCANIN	37	39	I	Scan port data input
SCANOUT	33	35	O	Scan port data output
SCANCLK	36	38	I	Scan port clock
SYNC	35	37	I	Scan port synchronization
TEST	34	36	I	C601: test modes
The scan port pins must be bonded out on any MSP50C601 production board. Consult the <i>Important Note regarding Scan Port Bond Out</i> , see Chapter 7 in the MSP50C614 User's Guide (SPSU014).				
Reference Oscillator Signals				
OSCOUT	49	51	O	Resistor/crystal reference out
OSCIN	48	50	I	Resistor/crystal reference in
PLL	47	49	O	Phase-lock-loop filter
Digital-to-Analog Sound Output (DAC)				
DACP	7	22	O	Digital-to-analog plus output (+)
DACM	5	20	O	Digital-to-analog minus output (–)
Initialization				
$\overline{\text{RESET}}$	38	40	I	Initialization
Power Signals				
VSS	17, 50, 90, 100†	32, 52, 9, 19†		Ground
VDD	6†, 8, 31, 32, 91	21†, 23, 33, 34, 10		Processor power (+)

† The VSS and VDD connections service the DAC circuitry. Their pins tend to sustain a higher current draw. A dedicated decoupling capacitor across these pins is therefore required.

MSP50C601 MIXED-SIGNAL PROCESSOR

SPSS029A – SEPTEMBER 2000 – REVISED FEBRUARY 2001

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage, V_{DD} (see Note 1)	–0.3 to 7 V
Supply current, I_{DD} (see Note 2)	35 mA
Input voltage range, V_I (see Note 1)	–0.3 to $V_{DD} + 0.3$ V
Output voltage range, V_O (see Note 1)	–0.3 to $V_{DD} + 0.3$ V
Storage temperature range, T_A	–30°C to 125°C

[†] Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. Unless otherwise noted, all voltages are measured with respect to V_{SS} .
2. The total supply current includes the current out of all the I/O pins as well as the operating current of the device.

recommended operating conditions

	MIN	MAX	UNIT
Supply voltage (with respect to V_{SS}), V_{DD}	3	5.2	V
CPU clock rate (as programmed), f_{CPU}	64	12,320	kHz
Load resistance between DAC_P and DAC_M , R_{DAC}	32		Ω
Operating free-air temperature, T_A	0	70	°C

timing requirements

	MIN	MAX	UNIT
$t_{(RESET)}$ Reset low pulse width, while V_{DD} is within specified limits	100		ns
$t1(WIDTH)$ Pulse width required prior to a negative transition at pin...PD3, PD5, or PF7 [‡]	2		$1/f_{CPU}$
$t2(WIDTH)$ Pulse width required prior to a positive transition at pin...PD2 or PD4 [‡]	2		$1/f_{CPU}$

[‡] While these pins are being used as interrupt inputs.

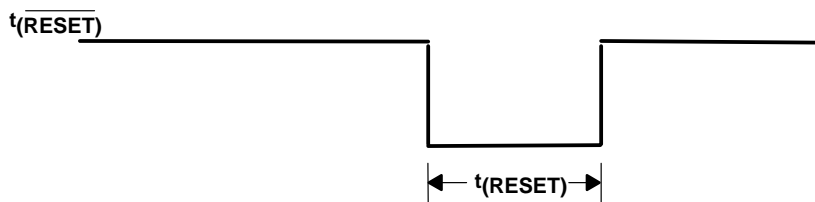


Figure 1. Initialization Timing Diagram

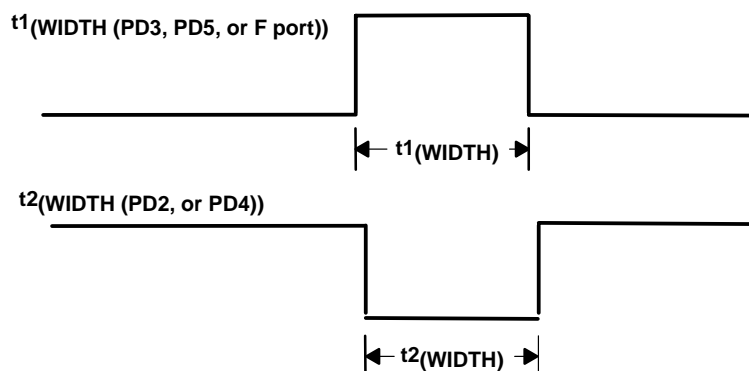


Figure 2. MSP50C601 External Interrupt Pin Pulse Width Requirements $t1_{WIDTH}$ and $t2_{WIDTH}$

MSP50C601

MIXED-SIGNAL PROCESSOR

SPSS029A – SEPTEMBER 2000 – REVISED FEBRUARY 2001

dc electrical characteristics, $T_A = 0^\circ\text{C} - 70^\circ\text{C}$

PARAMETER		TEST CONDITIONS		MIN	TYP [§]	MAX	UNIT	
<div>RESET</div>	Threshold changes	V _{DD} = 3 V	Positive going threshold	2.4		V		
			Negative going threshold	1.8				
			Hysteresis	0.6				
		V _{DD} = 5.2 V	Positive going threshold	3.3		V		
			Negative going threshold	2.9				
			Hysteresis	0.4				
V _{IH}	High-level input voltage	V _{DD} = 3 V		2	3		V	
		V _{DD} = 4.5 V		3	4.5			
		V _{DD} = 5.2 V		3.5	5.2			
V _{IL}	Low-level input voltage	V _{DD} = 3 V		0	1		V	
		V _{DD} = 4.5 V		0	1.5			
		V _{DD} = 5.2 V		0	1.7			
I _{OH} [¶]	High-level output current per pin of I/O port	V _{DD} = 4.5 V	V _{OH} = 4 V		−2		mA	
I _{OL} [¶]	Low-level output current per pin of I/O port		V _{OL} = 0.5 V		5		mA	
I _{OH} (DAC)	High-level output DAC current		V _{OH} = 4 V		−10		mA	
I _{OL} (DAC)	Low-level output DAC current		V _{OL} = 0.5 V		20		mA	
I _{lkg}	Input leakage current	Excludes OSC _{IN}				1	μA	
I _(STANDBY)	Standby current	RESET is low				0.05	10	μA
I _{DD} [†]	Operating current	V _{DD} = 4.5 V, F _{CLOCK} = 12.32 MHz		15		mA		
I _(SLEEP-deep)	Supply current	V _{DD} = 4.5 V, DAC off, ARM set, OSC disabled		0.05		10		μA
I _(SLEEP-mid)		V _{DD} = 4.5 V, DAC off, ARM set, OSC enabled		40		60		
I _(SLEEP-light)		V _{DD} = 4.5 V, DAC off, ARM clear, OSC enabled		60		100		
V _{IO}	Input offset voltage	V _{DD} = 4.5 V, V _{ref} = 1 to 4.25 V		25		50		mV
R(PULLUP)	F port pullup resistance	V _{DD} = 5 V				70	150	kΩ
Δf(RTO-trim)	Trim deviation	R _{RTO} = 470 kΩ, V _{DD} = 4.5 V, T _A = 25°C, f _{RTO} = 8.192 MHz (PLL setting = 7 Ch) [‡]				±1%	±3%	
Δf(RTO-volt)	Voltage deviation	R _{RTO} = 470 kΩ, V _{DD} = 3.5 to 5.2 V, T _A = 25°C, f _{RTO} = 8.192 MHz (PLL setting = 7 Ch) [‡]				±1.5%		
Δf(RTO-temp)	Temperature deviation	R _{RTO} = 470 kΩ, V _{DD} = 4.5 V, T _A = 0 to 70°C, f _{RTO} = 8.192 MHz (PLL setting = 7 Ch) [‡]				±0.03		%/°C
Δf(RTO-res)	Resistance deviation	V _{DD} = 4.5 V, T _A = 25°C, R _{OSC} = 470 kΩ at ±1%,				±1%		
		f _{RTO} = 8.192 MHz (PLL setting = 7 Ch) [‡]						

[†] Operating current assumes all inputs are tied to either V_{SS} or V_{DD} with no input currents due to programmed pullup resistors. The DAC output and other outputs are open circuited.

[‡] The best trim value is selected at nominal temperature and voltage but the deviation due to the trim error is ignored.

[§] Typical voltage and current measurement taken at 25°C

^{††} Cannot exceed 15 mA total per internal V_{DD} pin. Port A, B share 1 internal V_{DD} pin; Port C, D share 1 internal V_{DD} .

MSP50C601 MIXED-SIGNAL PROCESSOR

SPSS029A – SEPTEMBER 2000 – REVISED FEBRUARY 2001

external component absolute values

PARAMETER		TEST CONDITIONS		MIN	MAX	UNIT
R(RTO)	RTO external resistance	T _A = 25°C,	1% tolerance		470	kΩ
C(PLL)	PLL external capacitance	T _A = 25°C,	10% tolerance		3300	pF

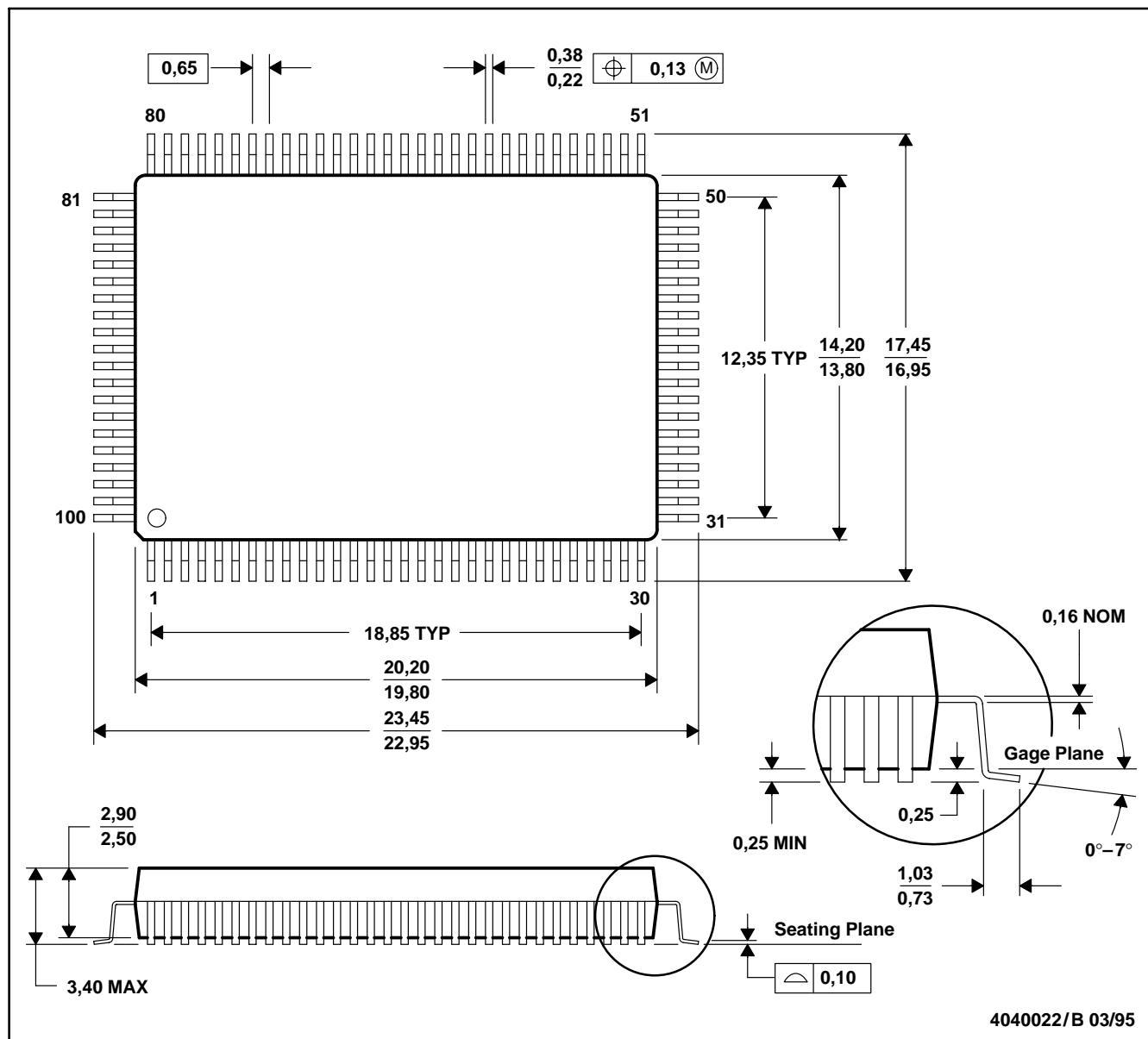
MSP50C601 MIXED-SIGNAL PROCESSOR

SPSS029A – SEPTEMBER 2000 – REVISED FEBRUARY 2001

MECHANICAL DATA

PJM (R-PQFP-G100)

PLASTIC QUAD FLATPACK



- NOTES: A. All linear dimensions are in millimeters.
B. This drawing is subject to change without notice.
C. Falls within JEDEC MS-022

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